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## **AMENDMENT TO THE CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application.

## **Listing of Claims:**

- 1. 8. (Canceled).
- 9. (Currently Amended) A polycrystalline silicon film on a buffer layer that is on a substrate, the polycrystalline film containing nickel metal of which density ranges  $2\times10^{17}$  to  $5\times10^{19}$  atoms/cm3, and an electrical conductivity activation energy between 0.53 eV and 0.71 eV, the polycrystalline silicon film comprising a plurality of needle-shaped silicon crystallites;

metal electrodes on opposite sides of the polycrystalline silicon film; and
an electric field substantially across the polycrystalline silicon between the metal
electrodes,

wherein the polycrystalline silicon film is formed by crystallizing an amorphous silicon film containing nickel metal by a thermal treatment carried in a temperature of 400 to 500 °C and due to the applying an electric field with metal electrodes, and

wherein the needle-shaped silicon crystallites are formed by movement of a silicide of the metal.

- 10. (Previously Presented) The polycrystalline silicon film according to claim 9, wherein the polycrystalline film includes one of gold(Au) and cobalt(Co) instead of nickel metal.
- 11. (Previously Presented) The polycrystalline silicon film according to claim 9, wherein the nickel metal works as a catalyst during the crystallization.

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## 12. - 19. (Canceled)

20. (New) A polycrystalline silicon film on a buffer layer that is on a substrate, the polycrystalline film containing nickel metal of which density ranges  $2 \times 10^{17}$  to  $5 \times 10^{19}$  atoms/cm3, and an electrical conductivity activation energy between 0.53 eV and 0.71 eV, the polycrystalline silicon film comprising a plurality of needle-shaped silicon crystallites;

metal electrodes on opposite sides of the polycrystalline silicon film;

an electric field substantially across the polycrystalline silicon between the metal electrodes; and

a heating element that heats the polycyrstaline silicon film,

wherein the polycrystalline silicon film is formed by crystallizing an amorphous silicon film containing nickel metal by heating the polycrystalline film to a temperature of 400 to 500 °C and due to the electric field, and

wherein the needle-shaped silicon crystallites are formed by movement of a silicide of the metal.